TG2000-10



Product Features

- GaN on SiC HEMT
- In/Out Impedance Matching
- Surface Mount Hybrid Type
- Small Size & Weight
- · High Efficiency
- Low Cost
- Custom design available

Applications

- · Radio System
- TRS(Trunked Radio System)
- RF Sub-Systems
- Base Station





Package Type: NP-18

Description

TG2000-10 have a high performance from 100 to 2000MHz. It has developed for Radio and TRS applications. Because using GaN-HEMT and AlN-board, it's effective for thermal problems. This TG2000-10 is designed using Psat of 10W. And adding 220nH of inductor to Drain Bias Network, this is used at the lower frequency of 20MHz.

Electrical Specifications @ V_{ds}=28V, Vgs@Idq, Ta=25 °C

PARAMETER	UNIT	MIN	TYP	MAX	CONDITION
Frequency Range	MHz	200	-	2000	ZS = ZL = 50 ohm
Power Gain @ P1dB		10	12	-	
Gain Flatness	dB	-	±1.0	-	
Input Return Loss		-5	-10	-	Vds = +28V
P1dB	dBm	37	38	-	Vgs@Idq
P3dB		-	40	-	Idq = 20mA
Efficiency @ P3dB	%	30	50	-	
Ids @ P3dB	mA	-	550	-	
Load Mismatch	-	-	5:1	-	All load phase
Supply Voltage	V	-	Vgs@Idq	-	Vgs
		-	28	-	Vds

Caution

The drain voltage must be supplied to the device after the gate voltage is supplied

Turn on : Turn on the Gate Voltage supply and last turn On the Drain voltage supplies

Turn off: Turn off the Drain Voltage and last turn off the Gate voltage

Note

TG Series have internal DC blocking capacitors at the RF input and output ports



Mechanical Specifications

PARAMETER	UNIT	ТҮР	REMARK
Mass	g	1	-
Dimension	mm	15 x 10 x 5.4	Outermost

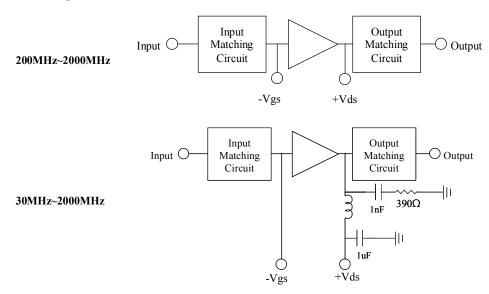
Absolute Maximum Ratings

PARAMETER	UNIT	RATING	SYMBOL
Gate-Source Voltage	V	-10 ~ 0	Vgs
Drain-Source Voltage	V	50	Vds
Gate Current	mA	3.6	Ig
Operating Junction Temperature	°C	225	T_{J}
Operating Case Temperature	°C	-40 ~ 85	T _C
Storage Temperature	°C	-40 ∼ 100	T_{STG}

Operating Voltages

PARAMETER	UNIT	MIN	TYP	MAX	SYMBOL
Drain Voltage	V	-	+28	-	Vds
Gate Voltage (on-state)	V	-	Vgs@Idq	-2	Vgs
Gate Voltage (off-state)	V	-	-8	-	Vgs

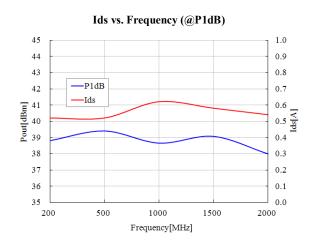
Block Diagram

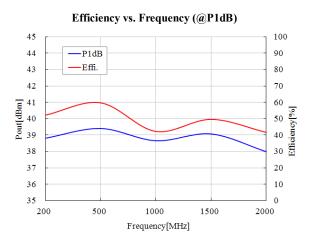


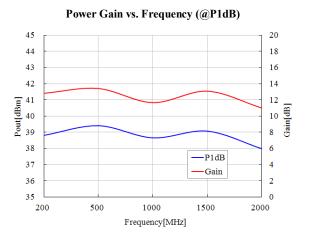


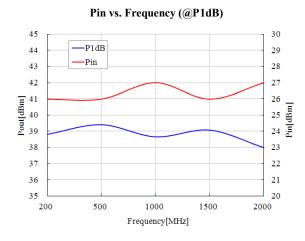
Performance Charts

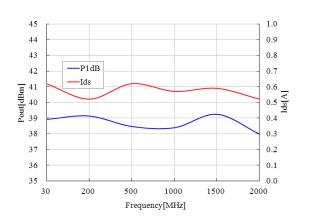
* Bias condition @ Idq=20mA, Vgs@Idq, Vds =+28V, Ta=25 °C



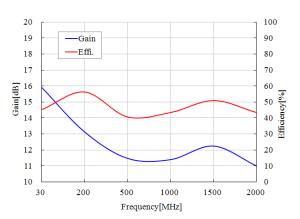








P1dB & Ids vs. Frequency (under 200MHz)

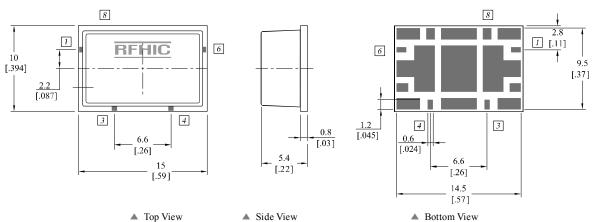


Gain & Efficiency vs. Frequency @P1dB (under 200MHz)



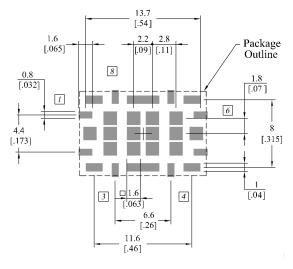
Package Dimensions (Type: NP-18)



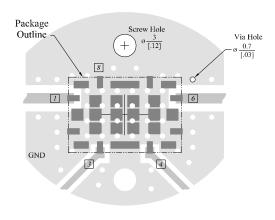


Pin Description									
Pin No Function Pin No Function				Pin No	Function	Pin No	Function		
1	RF Input	3	Gate Bias (-Vgs)	5	GND	7	GND		
2	GND	4	Drain Bias (+Vds)	6	RF Output	8	GND		

Recommended Pattern



Recommended Mounting Configuration



* Mounting Configuration Notes

- 1. For the proper performance of the device, Ground / Thermal via holes must be designed to remove heat.
- 2. To properly use heatsink, ensure the ground/thermal via hole region to contact the heatsink. We recommend the mounting screws be added near the heatsink to mount the board
- 3. In designing the necessary RF trace, width will depend upon the PCB material and construction.
- 4. Use 1 oz. Copper minimum thickness for the heatsink.
- 5. Do not put solder mask on the backside of the PCB in the region where the board contacts the heatsink
- 6. We recommend adding as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.

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Precautions

This product is a Gallium Nitride Transistor.

The Gallium Nitride Transistor requires a Negative Voltage Bias which operates alongside a Positive Voltage Bias. These Biases are applied in accordance to the Sequence during Turn-On and Turn-Off.

The Pallet Amplifier does not have a built-in Bias Sequence Circuit. Therefore, users need to either apply positive voltages and negative voltages in the required sequence, or add an external Bias Circuit to this Amplifier.

The required sequence for power supply is as follows.

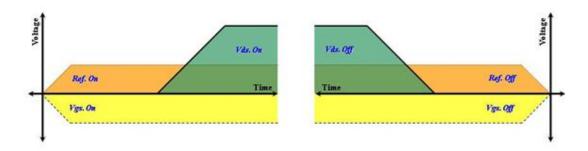
During Turn-On

- 1. Connect GND.
- 2. Apply Vgs.
- 3. Apply Vds.
- 4. Apply the RF Power.

During Turn-Off

- 1. Turn off RF power.
- 2. Turn off Vds, and then, turn off the Vgs.
- 3. Remove all connections.

Turn On



- Sequence Timing Diagram -

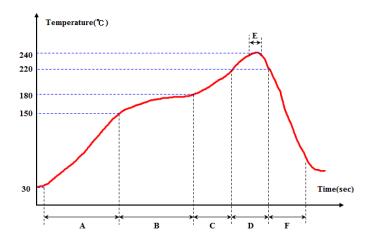


Reflow Profile

* Reflow oven settings

Zone	A	В	C	D	E	F
Temperature(°C)	30 ~ 150 ℃	150 ~ 180 ℃	180 ~ 220 ℃	220 ~ 220 ℃	235 ~ 240 ℃	$2 \sim 6$ °C/ Sec Drop
Belt speed	55 ~ 115 sec	55 ~ 75 sec	30 ∼ 50 sec	30 ∼ 50 sec	5 ~ 10 sec	60 ~ 90 sec

* Measured reflow profile



Ordering Information

Part Number	Package Design
	-R (Reel)
TG2000-10	-B (Bulk)
	- EVB (Evaluation Board)

Revision History

Part Number	Release Date	Version	Modification	Data Sheet Status
TG2000-10	2014.06.26	0.6	- A mass of mechanical specification is changed.	Preliminary
TG2000-10	2012.12.28	28 0.5 • Specifications of Absolute Maximum Ratings and Operating Voltages are changed.		Preliminary
TG2000-10	2012.11.08	0.4	 Idq of Test Condition is changed to 20mA. Solderability Characteristic information is supplemented. 	Preliminary

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